Surface Mount Type Crystal Units

Feature

Small size area and offers reduced height $(4.0 \times 2.5, 0.65 \pm 0.05)$. Hermetic sealing by Au-Sn method. Part is preconditioned to temperatures well beyond lead free reflow for unsurpassed reliability. High precision and high reliability. Excellent performance in ESR. Suitable for all Cellular Phones, NFC, Bluetooth, WLAN and Zigbee where ESR values are of concern. Product is lead free in construction. Can be mounted to PCB using a lead free solder reflow process.

Standard Specifications

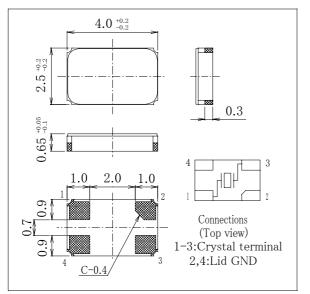
Size (mm)		4.0×2.5, 0.65t+0.05/-0.1
Overtone Order		Fundamental / 3rd Overtone
Frequency Range	Fundamental	12 ~ 60 (<i>See Table 1</i>)
(MHz)	3rd Overtone	$60 \sim 100$
Equivalent Series	Fundamental	150 max.
Resistance (Ω)	3rd Overtone	80 max.
Drive Level (µW)		50
Operating Temperature Range		See Table 2
Frequency Temperature Characteristics		See Table 2
(in reference to 25 °C)		

Table 2 Frequency Temperature Characteristics

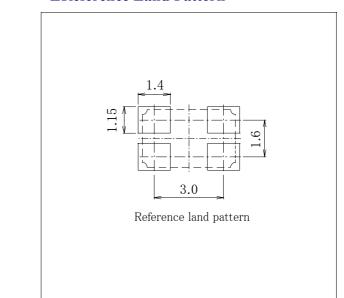
Temperature Range	Temperature Characteristics(×10 ⁻⁶)	Frequency Tolerance(×10 ⁻⁶)
-10 ~ 60 °C	±5	
-20 ~ 70 °C	±10	$\pm 10 \sim \pm 50$ (25 °C ± 3°C)
-30 ~ 85 °C	±15	

 Products with specific requirements are available request.

Outline Dimensions



■Reference Land Pattern



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Table 1 Typical Frequencies

Frequency (MHz)		
12.000	12.600	
13.000	14.400	
16.000	19.200	
19.680	19.800	
24.000	26.000	

